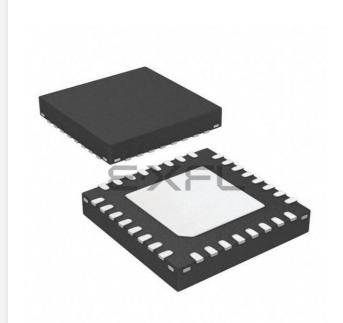
E·XFL



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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

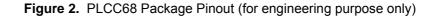
Details

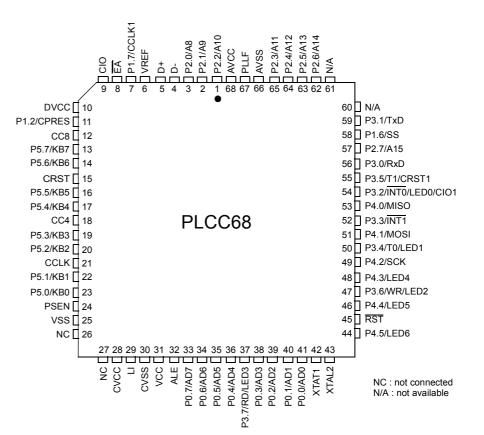
Product Status	Obsolete
Core Processor	CIP-51 8051
Core Size	8-Bit
Speed	72MHz
Connectivity	I ² C, SMBus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	29
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	<u>.</u>
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 3.6V
Data Converters	A/D 20x14b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	32-UFQFN Exposed Pad
Supplier Device Package	32-QFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm8lb11f32e-b-qfn32

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Low Pin Count Package Description

AT83C5123 version

Figure 6. VQFP32 Package Pinout

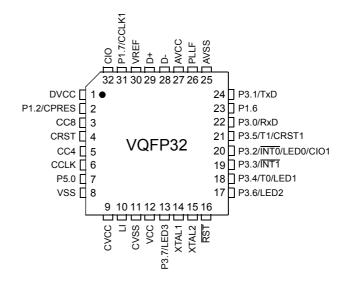
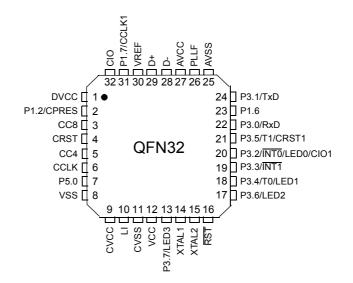
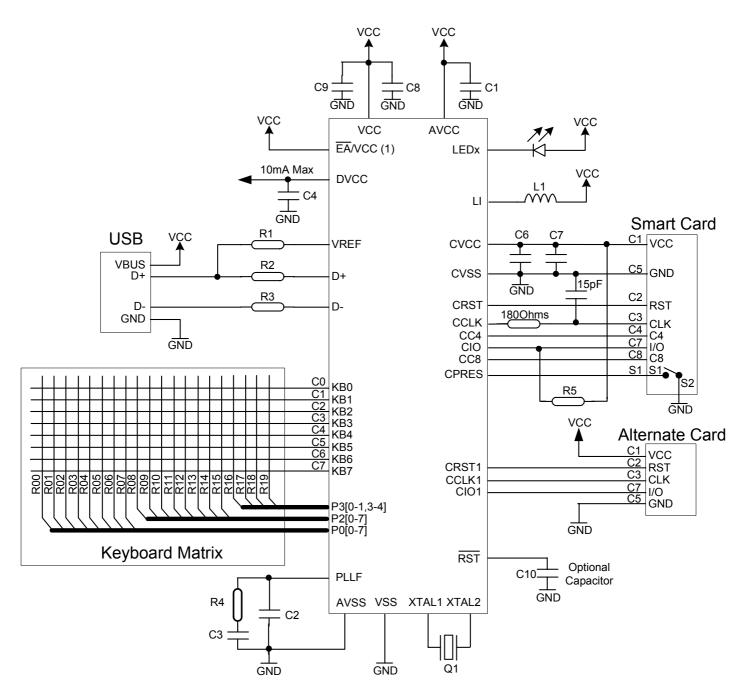


Figure 7. QFN32 Package Pinout





USB Keyboard with Smart Card Reader Using AT83R5122, AT8xC5122/AT89C5122DS



Notes : 1 - Pin configuration depends on product versions

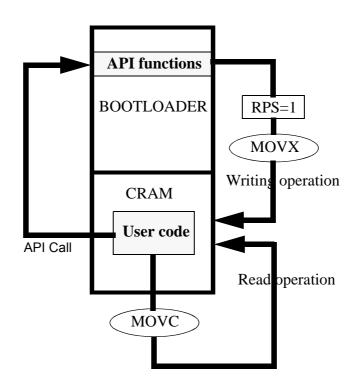
¹⁶ AT83R5122, AT8xC5122/23



Using CRAM Memory

The CRAM is a read / write volatile memory that is mapped in the program memory space. Then when the power is switched off the code is lost and needs to be reload at each power up. In return, the CRAM enables a lot of flexibility in the code development as it can be programmed indefinitely. The user code running in the CRAM can perform read operations in CRAM itself by means of MOVC instructions like any C51 microcontroller does. Although the writing operations in CRAM are usually handled by the bootloader, it is possible for the user code to handle its own writing operations in CRAM as well. The user code must call API functions provided by the bootloader in the ROM memory. Refer to bootloader datasheet for further details about the use of these API functions. These API functions use a mechanism provided by the AT8xC5122 microcontroller. When the bit RPS is set in RCON register (Table 8 on page 24), the MOVX intructions are configured to write in CRAM instead of XRAM memory. However, due to C51 architecture, it is not possible for the user code to write directly in CRAM when it is itself running in CRAM. This is why the API functions must be called in order to have the code executing in ROM while the CRAM is written.





Transmit / Receive Buffer

The contents of the SCIBUF Transmit / Receive Buffer is transferred or received into / from the Shift Register. The Shift Register is not accessible by microcontroller. Its role is to prepare the byte to be copied on the I/O pin for a transmission or in the SCIBUF buffer after a reception.

During a character transmission process, as soon as the contents of the SCIBUF buffer is transferred to the shift register, the SCTBE bit is set in SCISR register to indicate that the SCIBUF buffer is empty and ready to accept a new byte. This mechanism avoids to wait for the complete transmission of the previous byte before writing a new byte in the buffer and enables to speed up the transmission.

- If the Character repetition mode is not selected (bit CREP=0 in SCICR), as soon as the contents of the Shift Register is transferred to I/O pin, the SCTC bit is set in SCISR register to indicate that the byte has been transmitted.
- If the Character repetition mode is selected (bit CREP=1 in SCICR) The TERMINAL will be able to repeat characters as requested by the ICC (See the Parity Error in T=0 protocol description in the definition paragraph above). The SCTC bit in SCISR register will be set after a successful transmission (no retry or no further retry requested by the ICC). If the number of retries is exhausted (up to 4 retries depending on CREPSEL bit in SCSR) and the last retry is still unsuccessful, the SCTC bit in SCISR will not be set and the SCPE bit in SCISR register will be set instead.

During a character reception process, the contents of the Shift Register is transferred in the SCIBUF buffer.

- If the Character repetition mode is not selected (bit CREP=0 in SCICR), as soon as the contents of the Shift Register is transferred to the SCIBUF the SCRC bit is set in SCISR register to indicate that the byte has been received, and the SCIBUF contains a valid character ready to be red by the microcontroller.
- If the Character repetition mode is selected (bit CREP=1 in SCICR) The TERMINAL will be able to request repetition if the received character exhibit a parity error. Up to 4 retries can be requested depending on CREPSEL bit in SCSR. The SCRC bit will be set in SCISR register after a successful reception, first reception or after retry(ies). If the number of retries is exhausted (up to 4 retries depending on CREPSEL bit in SCSR) and the last retry is still unsuccessful, the SCRC bit and the SCPE bit in SCISR register will be set. It will be possible to read the erroneous character.

Warning : the SCTBI, SCTI SCRI and SCPI bits have the same function as SCTBE, SCTC, SCRC and SCPE bits. The first ones are able to generate interruptions if the interruptions are enabled in SCIER register while the second ones are only status bits to be used in pulling mode. If the interruption mode is not used, the status bits must be used. The SCTBI, SCTI and SCRI bits do not contain valid information while their respective interrupt enable bits ESCTBI, EXCTI, ESCRI are cleared.



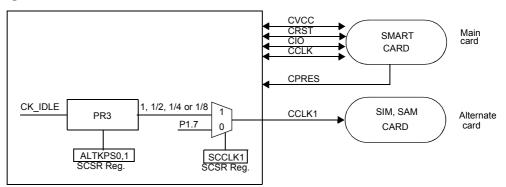


Alternate Card

A second card named 'Alternate Card' can be controlled.

The Clock signal CCLK1 can be adapted to the XTAL frequency. Thanks to the clock prescaler which can divide the frequency by 1, 2, 4 or 8. The bits ALTKPS0 and ALTKPS1 in SCSR Register are used to set this factor.

Figure 44. Alternate Card



Registers

There are fifteen registers to control the SCIB macro-cell. They are described from Table 58 to Table 45.

Some of the register widths are greater than a byte. Despite the 8 bits access provided by the BIU, the address mapping of this kind of register respects the following rule :

The Low significant byte register is implemented at the higher address.

This implementation makes access to these registers easier when using high level programming languages (C,C++).



Table 45. Smart Card Contacts Register - SCCON (S:ACh, SCRS=0)

7	6	5	4	3	2	1	0
CLK	-	CARDC8	CARDC4	CARDIO	CARDCLK	CARDRST	CARDVCC
Bit Number	Bit Mnemonic	Description					
7	CLK	Set this bit to us	use the Card CLK se CK_XTAL1 or Cl	K_PLL signals for (below) to drive Card CK_ISO to drive the CLK pin when switc	Card CLK pin (CC	EK = P1.4 pin)
6	-	Reserved This bit can be	changed by softwa	re but the read valu	ue is indeterminate.		
5	CARDC8	Set this bit to se The CC8 pin ca	•	e Card C8 pin (CC eudo bi-directional I	• •		in
4	CARDC4	Set this bit to se The CC4 pin ca	•	e Card C4 pin (CC eudo bi-directional I			'n
3	CARDIO	pseudo bi-direc To read from Cl value To write in ClO bit to write a 0 i	tional port : O (P1.0) port pin : (P1.0) port pin : set n CIO (P1.0) port p	set CARDIO (P1.0) CARDIO (P1.0) bi in.	les the use of the C) bit then read CARI t to write a 1 in CIO it be true to change	DIO (P1.0) bit to ha (P1.0) port pin , cle	ave the CIO port
2	CARDCLK			•	value of this bit is d t be true to change		
1	CARDRST	Set this bit to se	drive a low level or et a high level on th RDOK=1 (SCISR.4	e Card RST pin.	t be true to change	the state of Card R	ST pin
0	CARDVCC	effect while this	desactivate the Ca bit is cleared.		et its power-off. The a		-

Reset Value = 0X00 0000b



Table 49. Smart Card Selection Register - SCSR (S:ABh)

7	6	5	4	3	2	1	0	
-	BGTEN	-	CREPSEL	ALTKPS1	ALTKPS0	SCCLK1	SCRS	
Bit Number	Bit Mnemonic	Description						
7	-	Reserved The value read	from this bit is inde	terminate. Do not ch	nange this bit.			
6	BGTEN	Set this bit to se received from th counter is done	Block Guard Time Enable Set this bit to select the minimum interval between the leading edge of the start bits of the last character received from the ICC and the first character sent by the Terminal. The transfer of GT[8-0] value to the BGT counter is done on the rising edge of the BGTEN. Clear this bit to suppress the minimum time between reception and transmission.					
5	-	Reserved The value read	Reserved The value read from this bit is indeterminate. Do not change this bit.					
4	CREPSEL	Clear this bit to EMV)		smission (1 original - nission (1 original + :	. ,			
3-2	ALTKPS1:0	00 ALTKPS = 0 01 ALTKPS = 1 10 ALTKPS = 2	Alternate Card Clock prescaler factor 00 ALTKPS = 0: prescaler factor equals 1 01 ALTKPS = 1: prescaler factor equals 2 10 ALTKPS = 2: prescaler factor equals 4 (reset value) 11 ALTKPS = 3: prescaler factor equals 8					
1	SCCLK1	Set to select the	Alternate card clock selection Set to select the prescaled PR3 clock for CCLK1 (P1.7) pin Clear to select P1.7 port bit					
0	SCRS		Smart Card Register Selection The SCRS bit selects which set of the SCIB registers is accessed.					

Reset Value = X000 1000b

Table 50. Smart Card Transmit / Receive Buffer - SCIBUF (S:AA)

7	6	5	4	3	2	1	0		
-	-	-	-	-	-	-	-		
Bit Number	Bit Mnemonic	Description							
-	-	The bits are sorted	e written in the buf and copied on the ved from I/O pin is	fer to be transmitted I/O pin versus the ready to be read wh	active convention.				

Reset Value = 0000 0000b

AT83R5122, AT8xC5122/23

USB Controller

The AT8xC5122D implements a USB device controller supporting Full Speed data transfer. In addition to the default control endpoint 0, it provides 6 other endpoints, which can be configured in Control, Bulk, Interrupt or Isochronous modes:

- Endpoint 0: 32-byte FIFO, default control endpoint
- Endpoint 1,2,3: 8-byte FIFO
- Endpoint 4,5: 64-byte FIFO
- Endpoint 6: 2 x 64-byte Ping-pong FIFO

This allows the firmware to be developed conforming to most USB device classes, for example:

- USB Mass Storage Class Control/Bulk/Interrupt (CBI) Transport, Revision 1.0 -December 14, 1998.
- USB Mass Storage Class Bulk-Only Transport, Revision 1.0 September 31, 1999.
- USB Human Interface Device Class, Version 1.1 April 7, 1999.
- USB Device Firmware Upgrade Class, Revision 1.0 May 13, 1999.

USB Mass Storage Classes

USB Mass Storage Class CBI Within the CBI framework, the Control endpoint is used to transport command blocks as well as to transport standard USB requests. One Bulk-Out endpoint is used to transport data from the host to the device. One Bulk-In endpoint is used to transport data from the device to the host. And one interrupt endpoint may also be used to signal command completion (protocol 0); it is optional and may not be used (protocol 1).

The following configuration adheres to these requirements:

- Endpoint 0: 8 bytes, Control In-Out
- Endpoint 4: 64 bytes, Bulk-Out
- Endpoint 5: 64 bytes, Bulk-In
- Endpoint 1: 8 bytes, Interrupt In

USB Mass Storage Class Bulk-Only Transport Within the Bulk-Only framework, the Control endpoint is only used to transport classspecific and standard USB requests for device set-up and configuration. One Bulk-Out endpoint is used to transport commands and data from the host to the device. One Bulk-In endpoint is used to transport status and data from the device to the host. No interrupt endpoint is needed.

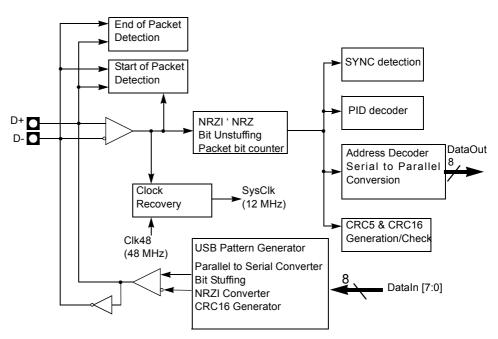
The following configuration adheres to these requirements:

- Endpoint 0: 8 bytes, Control In-Out
- Endpoint 4: 64 bytes, Bulk-Out
- Endpoint 5: 64 bytes, Bulk-In

USB Device Firmware Upgrade (DFU) The USB Device Firmware Update (DFU) protocol can be used to upgrade the on-chip program memory of the AT8xC5122D. This allows the implementation of product enhancements and patches to devices that are already in the field. Two different configurations and description sets are used to support DFU functions. The Run-Time configuration co-exists with the usual functions of the device, which may be USB Mass Storage for the AT8xC5122D. It is used to initiate DFU from the normal operating mode. The DFU configuration is used to perform the firmware update after device re-configuration and USB reset. It excludes any other function. Only the default control pipe (endpoint 0) is used to support DFU services in both configurations.

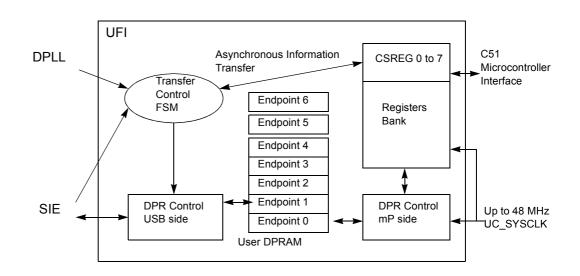






Function Interface Unit (UFI) The Function Interface Unit provides the interface between the AT8xC5122D (or AT83C5123) and the SIE. It manages transactions at the packet level with minimal intervention from the device firmware, which reads and writes the endpoint FIFOs.

Figure 50. UFI Block Diagram





USB Interrupt System

Interrupt System Priorities

Figure 62. USB Interrupt Control System

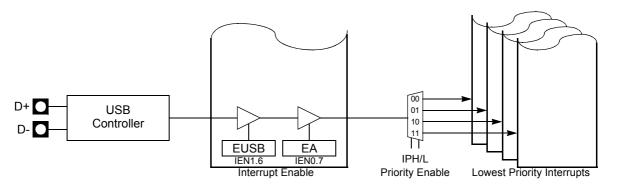


Table 63. Priority Levels

IPHUSB	IPHUSB IPLUSB USB Priority				
IFIUSB	IFE03B	USB Priority Level			
0	0	0 Lowest			
0	1	1			
1	0	2			
1	1	3 Highest			

Interrupt Control System

As shown in Figure 63, many events can produce a USB interrupt:

- TXCMPL: Transmitted In Data (Table 70 on page 119). This bit is set by hardware when the Host accept a In packet.
- RXOUTB0: Received Out Data Bank 0 (Table 70 on page 119). This bit is set by hardware when an Out packet is accepted by the endpoint and stored in bank 0.
- RXOUTB1: Received Out Data Bank 1 (only for Ping-Pong endpoints) (Table 70 on page 119). This bit is set by hardware when an Out packet is accepted by the endpoint and stored in bank 1.
- RXSETUP: Received Setup (Table 70 on page 119). This bit is set by hardware when an SETUP packet is accepted by the endpoint.
- NAKIN and NAKOUT: These bits are set by hardware when a Nak Handshake has been received on the corresponding endpoint. These bits are cleared by software.
- STLCRC: STALLED (only for Control, Bulk and Interrupt endpoints) (Table on page 120). This bit is set by hardware when a STALL handshake has been sent as requested by STALLRQ, and is reset by hardware when a SETUP packet is received.
- SOFINT: Start Of Frame Interrupt (Table 65 on page 116). This bit is set by hardware when a USB start of frame packet has been received.
- WUPCPU: Wake-Up CPU Interrupt (Table 65 on page 116). This bit is set by hardware when a USB resume is detected on the USB bus, after a SUSPEND state.
- SPINT: Suspend Interrupt (Table 65 on page 116). This bit is set by hardware when a USB suspend is detected on the USB bus.





Serial I/O Port The serial I/O port in the AT83R5122, AT8xC5122/23 is compatible with the serial I/O port in the 80C52.

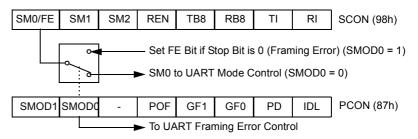
The I/O port provides both synchronous and asynchronous communication modes. It operates as an Universal Asynchronous Receiver and Transmitter (UART) in three full-duplex modes (Modes 1, 2 and 3). Asynchronous transmission and reception can occur simultaneously and at different baud rates

Serial I/O port includes the following enhancements:

- Framing error detection
- Automatic address recognition

Framing Error Detection Framing bit error detection is provided for the three asynchronous modes (Modes 1, 2 and 3). To enable the framing bit error detection feature, set SMOD0 bit in PCON register (See Figure 64).

Figure 64. Framing Error Block Diagram



When this feature is enabled, the receiver checks each incoming data frame for a valid stop bit. An invalid stop bit may result from noise on the serial lines or from simultaneous transmission by two CPUs. If a valid stop bit is not found, the Framing Error bit (FE) in SCON register (See Figure 69 on page 128) bit is set.

Software may examine FE bit after each reception to check for data errors. Once set, only software or a reset can clear FE bit. Subsequently received frames with valid stop bits cannot clear FE bit. When FE feature is enabled, RI rises on stop bit instead of the last data bit (See Figure 65 and Figure 66).

Figure 65. UART Timings in Mode 1

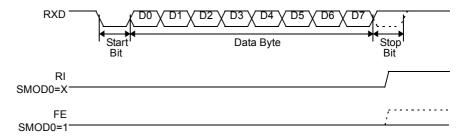
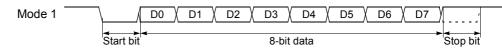


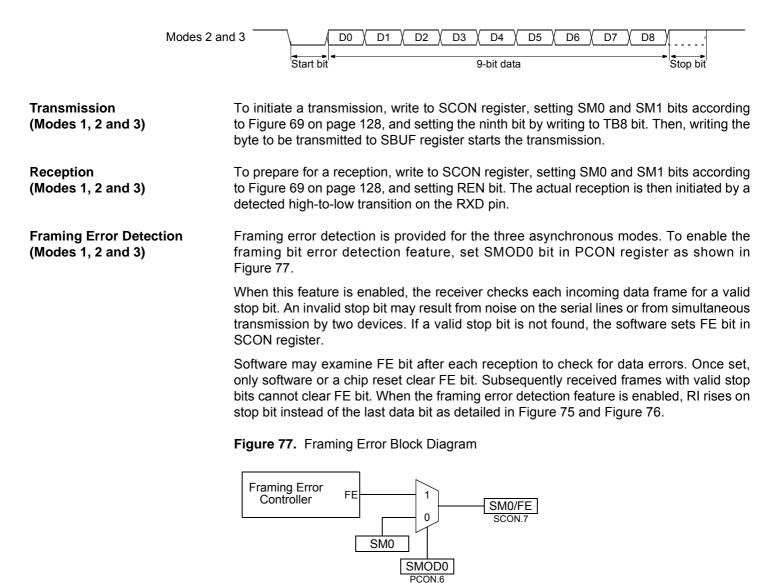


Figure 75. Data Frame Format (Mode 1)



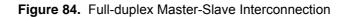
Modes 2 and 3 Modes 2 and 3 are full-duplex, asynchronous modes. The data frame (see Figure 76) consists of 11 bits: one start bit, eight data bits (transmitted and received LSB first), one programmable ninth data bit and one stop bit. Serial data is transmitted on the TXD pin and received on the RXD pin. On receive, the ninth bit is read from RB8 bit in SCON register. On transmit, the ninth data bit is written to TB8 bit in SCON register. Alternatively, you can use the ninth bit as a command/data flag.

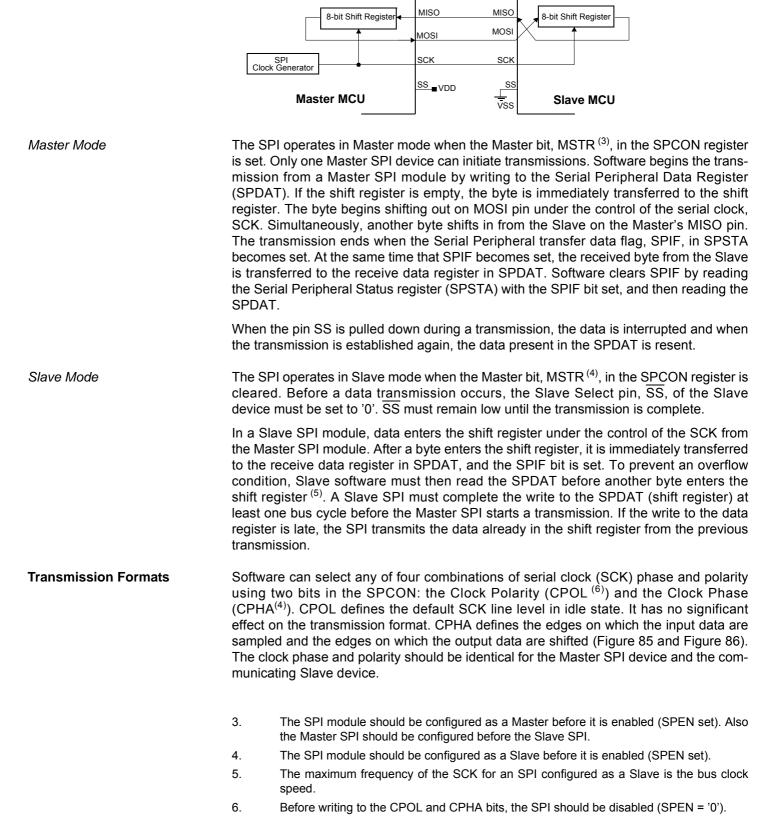
Figure 76. Data Frame Format (Modes 2 and 3)



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¹³⁸ AT83R5122, AT8xC5122/23



7	6	5	4	3	2	1	0	
-	PUSBL	-	-	PSCIL	PSPIL	-	PKBDL	
Bit Number	Bit Mnemonic	Description						
7	-	Reserved The value rea	•					
6	PUSBL		USB Interrupt Priority bit Refer to PUSBH for priority level.					
5 - 4	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not change these bits.					
3	PSCIL		SCI Interrupt Priority bit Refer to PSPIH for priority level.					
2	PSPIL		SPI Interrupt Priority bit Refer to PSPIH for priority level.					
1	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not change this bit.					
0	PKBL		Keyboard Interrupt Priority bit Refer to PKBDH for priority level.					

Table 103. Interrupt Priority Low Register 1 - IPL1 (B2h) for AT8xC5122

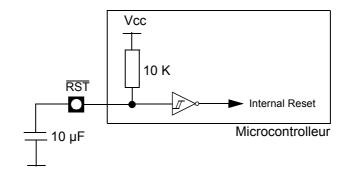
Reset Value = X00X 00X0b (Bit addressable)

Reset pin

As explained in the POR section there is no need to use the reset pin as the internal reset function at power up is ensured by the POR. Anyway, if some applications requires a long reset, a reset controlled by the user or a reset controlled by external superviser device, the use of the reset pin is necessary.

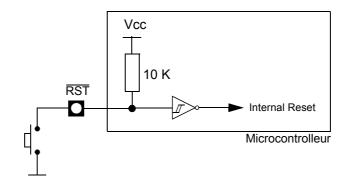
Long Reset As the pad integrates an internal pull-up of 10K, only an external capacitor of at least 10 μ F is required to have an impact on the reset duration.

Figure 103. Long Reset



Reset Controlled by the User The external capacitor is not needed if no long reset is required.

Figure 104. Reset Controlled by the User



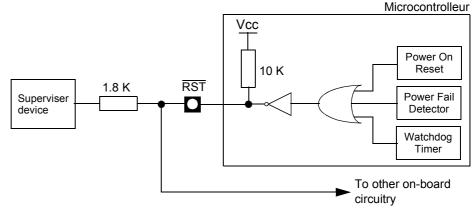


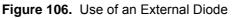


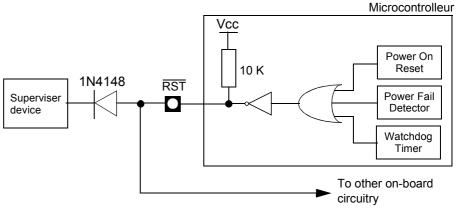
Reset Controlled by an External Superviser Device

As the reset pin can be forced in output by the Watch-Dog timer (WDT) or the POR/PFD features, there can be a conflict between the external superviser device and the microcontroller's reset pin when in one side the external superviser is pulling the reset pin to VCC and in another side the WDT or POR/PFD features tries to force the reset pin to ground. Therefore, it recommended to insert a series resistor of 1.8K +/-10% or a diode (1N4148 for instance) between the external superviser device and the reset pin as detailed in the following figures.











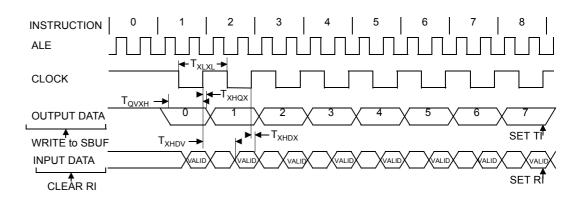
USB Interface

Figure 112. USB Interface

Symbol	Parameter	Min	Тур ⁽⁵⁾	Max	Unit
V _{REF}	USB Reference Voltage	3.0		3.6	V
V _{IH}	Input High Voltage for D+ and D- (driven)	2.0		4.0	V
V _{IHZ}	Input High Voltage for D+ and D- (floating)	2.7		3.6	V
V _{IL}	Input Low Voltage for D+ and D-			0.8	V
V _{OH}	Output High Voltage for D+ and D-	2.8		3.6	V
V _{OL}	Output Low Voltage for D+ and D-	0.0		0.3	V



Shift Register Timing Waveform

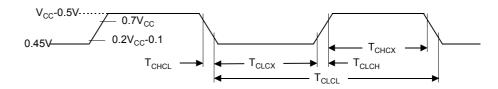


External Clock Drive Characteristics (XTAL1)

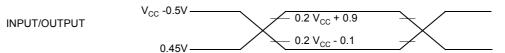
Table 120. AC Parameters

Symbol	Parameter	Min	Мах	Units
T _{CLCL}	Oscillator Period	125		ns
T _{CHCX}	High Time	5		ns
T _{CLCX}	Low Time	5		ns
T _{CLCH}	Rise Time		5	ns
T _{CHCL}	Fall Time		5	ns
T _{CHCX} /T _{CLCX}	Cyclic ratio in X2 mode	40	60	%

External Clock Drive Waveforms



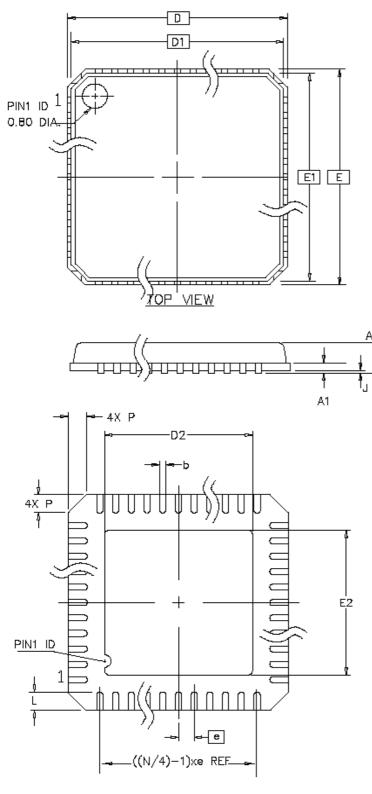
AC Testing Input/Output Waveforms



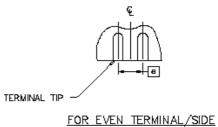
AC inputs during testing are driven at V_{CC} - 0.5 for a logic "1" and 0.45V for a logic "0". Timing measurement are made at V_{IH} min for a logic "1" and V_{IL} max for a logic "0".

¹⁹⁶ AT83R5122, AT8xC5122/23

QFN32 Package



BOTTOM VIEW



	ММ					
	MIN	NOM	МАХ	MIN	NDM	MAX
Α	-	0.85	0.90	-	. D33	. 035
L	D. DO	0.01	0.05	. 000	. 000	. 002
A1		0. 20	ref		008	ref
D/E		7,00	BSC		276 3	BSC
D1/E1		6, 75	B2C		266 3	BSC
D2/E2	4. 95	5.10	5. 25	. 195	. 201	. 207
Ν			З	2		
P	0.24	0. 42	0.60	. 009	.016	. 024
e	0.65 BSC				026 3	BSC
L	0.50	0.60	0.75	. 020	. 024	. 030
b	0, 23	0, 28	0, 35	. 009	.011	.014

